



SURFACE MOUNT LOW LEAKAGE DIODE

Product Summary (@TA = +25°C)

| V _R | I _R | t _{rr} |
|----------------|----------------|-----------------|
| 85V | 5nA | 3µs |

Description

The BAV116HWFQ is an 85V, 5nA and 3µs switching diode that is optimized for ultra-low leakage current.

Applications

It is ideally suited for use in applications such as the following:

- Mobile
- Portable Electronics
- Consumer Electronics
- Automotive

Features

- Ultra Low Leakage Current (5nA @ V_R = 75V)
- Flat Leadframe Design for Improved Thermal Transfer
- Low Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Matte Tin Finish Annealed over Copper Alloy Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.018 grams (Approximate)

SOD123F







Bottom View



Ordering Information (Note 5)

| Product | Compliance | Case | Packaging |
|--------------|------------|---------|-------------------|
| BAV116HWFQ-7 | Automotive | SOD123F | 3,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SOD123F



TW = Product Type Marking Code YM = Date Code Marking

Y = Year (ex.: C = 2015) M = Month (ex: O = October)

Bar Denotes Cathode Side

Date Code Key

| Year | 201 | 5 | 2016 | | 2017 | 20 | 18 | 2019 | | 2020 | 2 | 2021 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | С | | D | | E | | F | G | | Н | | 1 |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|--|-------------------|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 85 | V | |
| RMS Reverse Voltage | V _{R(RMS)} | 60 | V | |
| Forward Continuous Current (Note 6) | I _{FM} | 215 | mA | |
| Repetitive Peak Forward Current | I _{FRM} | 500 | mA | |
| Non-Repetitive Peak Forward Surge Current | I _{FSM} | 4.0 1.0 0.5 | А | |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation (Note 6) | P_{D} | 375 | mW |
| Thermal Resistance Junction to Ambient Air (Note 6) | R _{θJA} | 330 | °C/W |
| Thermal Resistance Junction to Solder Point | R _{0JSP} | 70 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

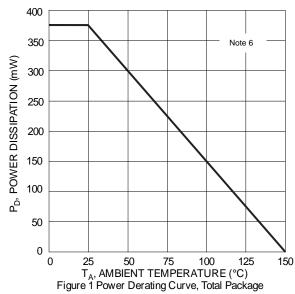
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

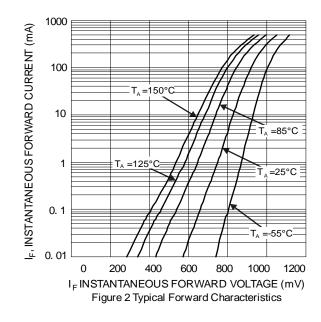
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|-----|---------------------------|------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$ | 85 | _ | _ | ٧ | $I_R = 100\mu A$ |
| Forward Voltage | VF | _ | _ | 0.9 1.0 1.1 1.25 | V | I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA |
| Leakage Current (Note 7) | I _R | _ | _ | 5.0 80 | | V _R = 75V V _R = 75V, T _J = +150°C |
| Total Capacitance | C _T | _ | 2 | _ | pF | $V_R = 0, f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | | | 3.0 | μs | $\begin{split} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \text{ x } I_R, \text{ R}_L = 100 \Omega \end{split}$ |

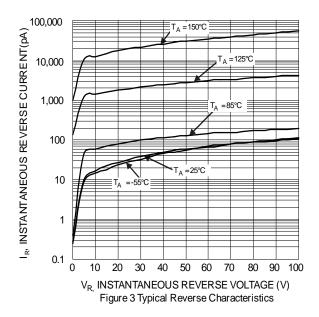
Notes:

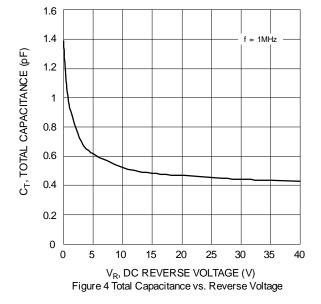
^{6.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 7. Short duration pulse test used to minimize self-heating effect.









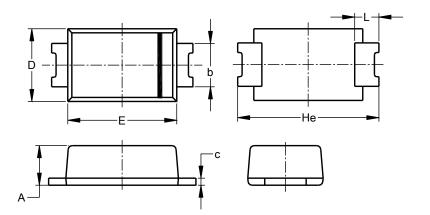




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SOD123F (Type B)

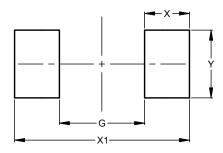


| SOD123F (Type B) | | | | | | | |
|----------------------|------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.81 | 1.15 | _ | | | | |
| b | 0.80 | 1.35 | | | | | |
| С | 0.05 | 0.30 | | | | | |
| D | 1.70 | 1.90 | 1.80 | | | | |
| Е | 2.60 | 2.80 | 2.70 | | | | |
| Не | 3.30 | 3.70 | 3.50 | | | | |
| L | 0.35 | 0.85 | _ | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOD123F (Type B)



| Dimensions | Value |
|------------|---------|
| | (in mm) |
| G | 1.90 |
| Х | 1.00 |
| X1 | 3.90 |
| | 1.50 |



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